



DMT6015LFV

#### 60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	$16m\Omega @ V_{GS} = 10V$	35A
60V	$22m\Omega @ V_{GS} = 4.5V$	28A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$ , yet maintain superior switching performance, making it ideal for high efficiency power management applications.

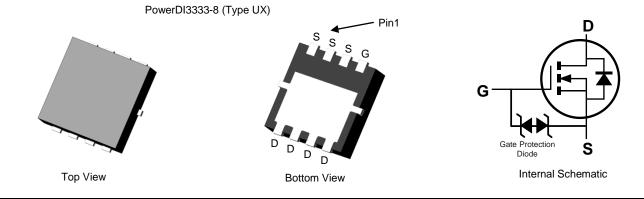
- Motor Control
- DC-DC Converters
- Power Management

#### **Features and Benefits**

- Low R<sub>DS(ON)</sub> Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8 (Type UX)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMT6015LFV-7	PowerDI3333-8 (Type UX)	2,000/Tape & Reel
DMT6015LFV-13	PowerDI3333-8 (Type UX)	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

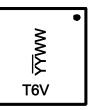
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

# **Marking Information**

Notes:



<u>T6V=</u> Product Type Marking Code <u>YYWW = Date Code Marking</u> YY = Last Digit of Year (ex: 16 = 2016) WW = Week Code (01 ~ 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage	V <sub>GSS</sub>	±16	V	
	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	9.5 7.6	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	ID	35 22	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	60	A
Maximum Continuous Body Diode Forward Current (Note 5)	ls	2	A	
Avalanche Current, L = 0.1mH	I <sub>AS</sub>	10	A	
Avalanche Energy, L = 0.1mH	E <sub>AS</sub>	5	mJ	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

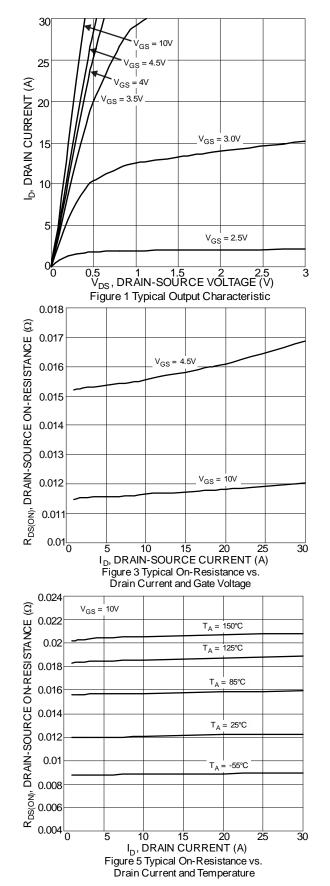
Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	Π-	2.2	W
Total Power Dissipation (Note 5)	$T_{\rm C} = +25^{\circ}{\rm C}$	PD	30	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Devi	57	°C/W
merinal Resistance, Junction to Ambient (Note 5)	t<10s	R <sub>θJA</sub>	35	
Thermal Resistance, Junction to Case (Note 5)		$R_{\theta JC}$	4.2	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

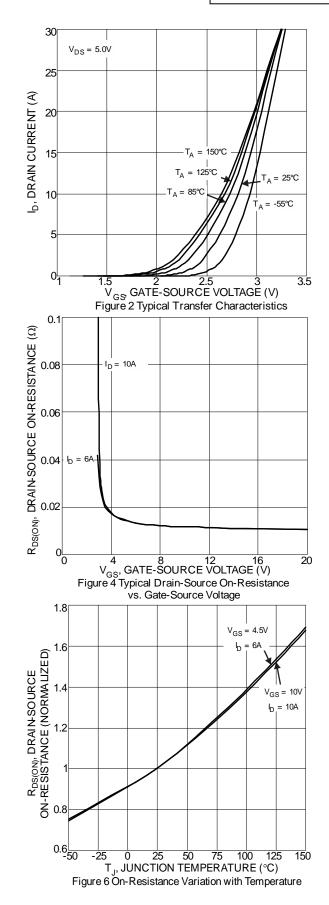
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	—	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	—	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	11.7	16	mΩ	$V_{GS} = 10V, I_D = 10A$	
	R <sub>DS(ON)</sub>	_	15.7	22	mΩ	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V <sub>SD</sub>	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C <sub>ISS</sub>		1103		pF		
Output Capacitance	C <sub>OSS</sub>		251		pF	− V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, − f = 1MHz	
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	20	—	pF		
Gate Resistance	R <sub>G</sub>	_	1.5	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_G$	_	8.9	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_{G}$		18.9	_	nC		
Gate-Source Charge	Q <sub>GS</sub>	—	3	—	nC	$V_{DS} = 30V, I_D = 10A$	
Gate-Drain Charge	Q <sub>GD</sub>	—	2.8	—	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.1	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	7.1	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		19.5	_	ns	$R_G = 6\Omega$ , $I_D = 10A$	
Turn-Off Fall Time	t <sub>F</sub>		8.6		ns	1	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	—	21.2	_	ns	I <sub>F</sub> = 10A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	—	13.2	—	nC		

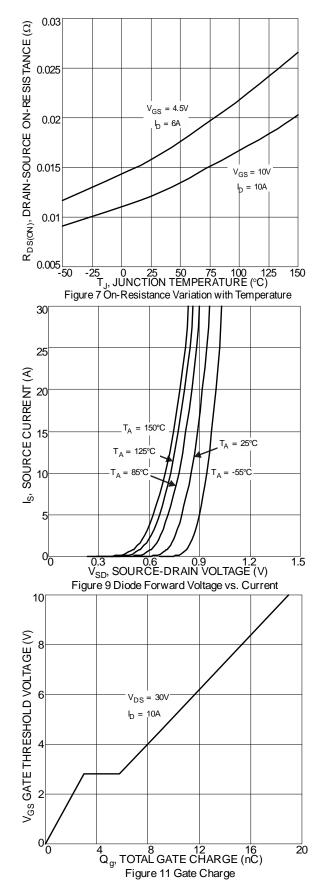
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate Notes: 6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.

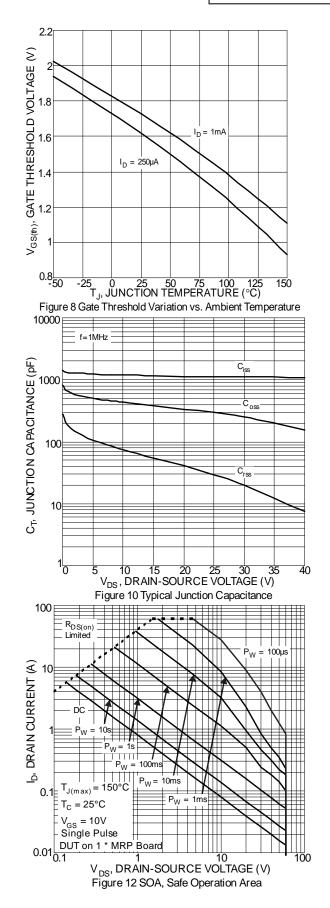




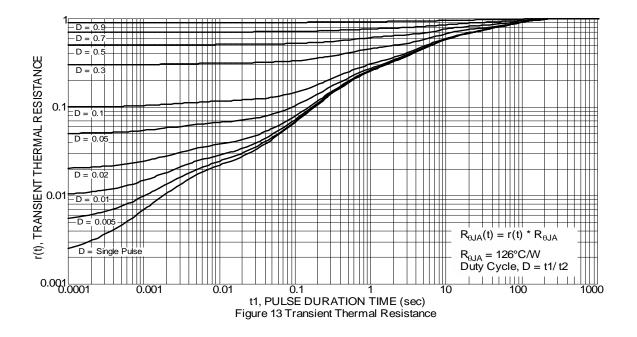








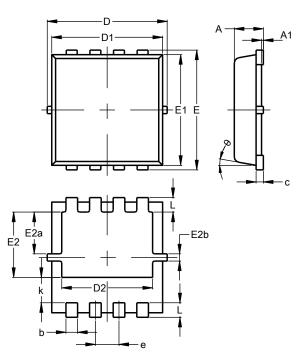






### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

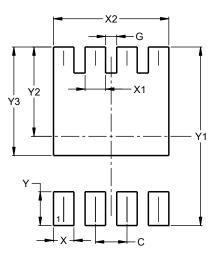


	PowerDI3333-8 (Type UX)					
Dim	Min	Max Typ				
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
E	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E2a	0.95	1.35	1.15			
E2b	0.10	0.30	0.20			
е	0.65 BSC					
k	0.50	0.90	0.70			
L	0.30	0.50	0.40			
θ	0°	12°	10°			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (Type UX)



Dimensions	Value (in mm)
С	0.650
G	0.230
Х	0.420
X1	0.420
X2	2.370
Y	0.700
Y1	3.700
Y2	1.850
Y3	2.250

#### PowerDI3333-8 (Type UX)



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